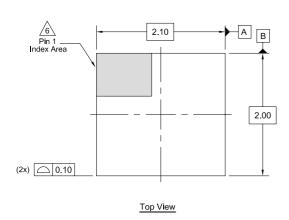
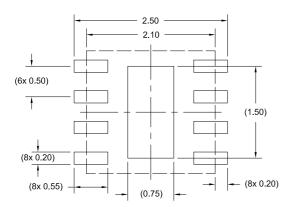
Plastic Packages for Integrated Circuits

Package Outline Drawing

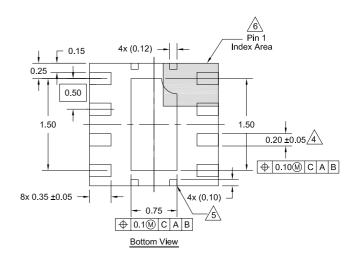
L8.2.1x2.0Z

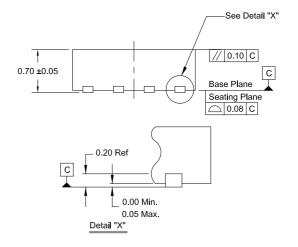
8 Lead Optical Dual Flat No-lead Plastic Package (ODFN) Rev 0, 5/2021





Typical Recommended Land Pattern





Notes:

- 1. Dimensions are in millimeters.
 - Dimensions in () for reference only.
- 2. Dimensioning and tolerancing conform to ASME Y14.5m-1994.
- 3. Unless otherwise specified, tolerance: Decimal ±0.05
- Dimension applies to the metallized terminal and is measured between 0.25mm and 0.35mm from the terminal tip.
- Tiebar shown (if present) is a non-functional feature connected to paddle for mechanical locking purpose.
 - The configuration of the pin #1 identifier is optional, but must be located within the zone indicated. The pin #1 identifier may be either a mold or mark feature.

